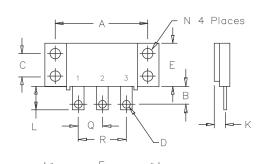
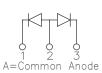
Schottky PowerMod FST16135 — FST16145









ntae.

Baseplate: Nickel plated copper;

electrically isolated Pins: Nickel plated copper

Dim.	Inches	Mil	limeters	
Min.	Max.	Min.	Max.	Notes
A 1.995	2.005	50.67	50.93	
B 0.300	0.325	7.62	8.26	
C 0.495	0.505	12.57	12.83	
D 0.182	0.192	4.62	4.88	Dia.
E 0.990	1.010	25.15	25.65	
F 2.390	2.410	60.71	61.21	
G 1.500	1.525	38.10	38.70	
H 0.120	0.130	3.05	3.30	
J	0.400		10.16	
K 0.240	0.260	6.10	6.60 to	Lead (
L 0.490	0.510	12.45	12.95	_
M 0.330	0.350	8.38	6.90	
N 0.175	0.195	4.45	4.95	Dia.
P 0.035	0.045	0.89	1.14	
Q 0.445	0.455	11.30	11.56	
R 0.890	0.910	22.61	23.11	

T0 - 249

Microsemi	Microsemi	Working Peak	Repetitive Peak
Catalog Number	Catalog Number	Reverse Voltage	Reverse Voltage

FST16135*	160CMQ035	35V	35V
FST16140*	160CMQ040	40 V	40V
FST16145*	160CMQ045	45V	45V

*Add the Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring for Reverse Protection
- Low Forward Voltage
- VRRM 35 to 45 Volts
- Electrically Isolated base
- Reverse Energy Tested
- Center top
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg

Average forward current per leg

Maximum surge current per leg

Max repetitive peak reverse current per leg

Max peak forward voltage per leg

Max peak forward voltage per leg

Max peak reverse current per leg

Max peak reverse current per leg

Max peak forward voltage per leg

Max peak reverse current per leg

Max peak reverse current per leg

RM 500 mA

TC = 67°C, Square wave, R \theta JC = 0.5°C/W

Amps
TC = 67°C, Square wave, R \theta JC = 1.0°C/W

8.3 ms, half sine T J = 175°C

Amps
FM = 80A: T J = 125°C*

Volts
FM = 80A: T J = 25°C*

*Pulse test: Pulse width 300µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

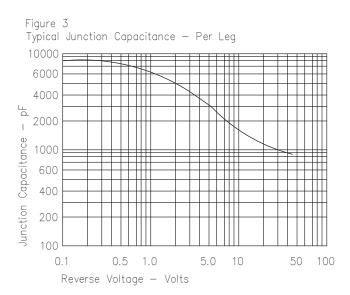
TSTG -55°C to 175°C -55°C to 175°C Storage temp range TJ Operating junction temp range Maximum thermal resistance per leg $\mathsf{R} \ominus \mathsf{JC}$ 1.0°C/W Junction to case $\mathsf{R} \ominus \mathsf{JC}$ 0.5°C/W Junction to case Maximum thermal resistance per pkg. Recs 0.1°C/W Typical thermal resistance (greased) Case to sink 15 - 20 inch pounds Mounting torque Weight 2.5 ounces (71 grams) typical

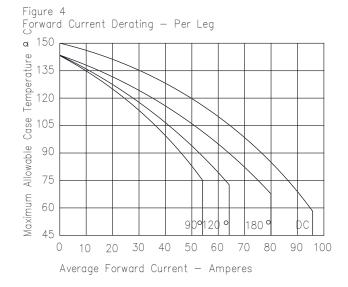


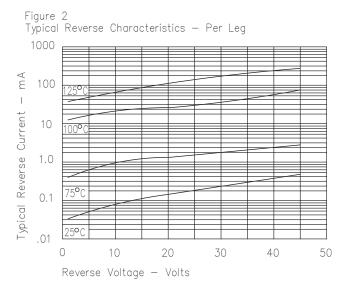
Max peak reverse current per leg Typical junction capacitance per leg

FST16135 - FST16145

Figure 1 Typical Forward Characteristics - Per Leg 800 600 400 200 100 80 60 40 Instantaneous Forward Current — Amperes 20 10 8.0 6.0 4.0 2.0 1.0 .3 .5 .7 .9 1.1 1.3 1.5 Instantaneous Forward Voltage — Volts









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